

# SUL60512 Sink and Source DDR Termination Regulator

## General Description

The SUL60512 is a linear regulator designed to meet the JEDEC SSTL (Series Stub Termination Logic) specifications in DDRI/II/III/IIIL/IV –SDRAM systems.

It is designed for the system which has low input voltage, low cost, low noise, and space consideration.

The SUL60512 provides accurate and fast response with amperage source/sink ability in load transient to track reference voltage with typically 20 $\mu$ F output capacitor. The terminated voltage can be generated by two external resistors or programmed by forcing REFIN pin at a desired voltage.

Also the SUL60512 provides an open-drain PGOOD flag which monitors the output regulation and an EN signal to discharge VTT during STR (S3) mode.

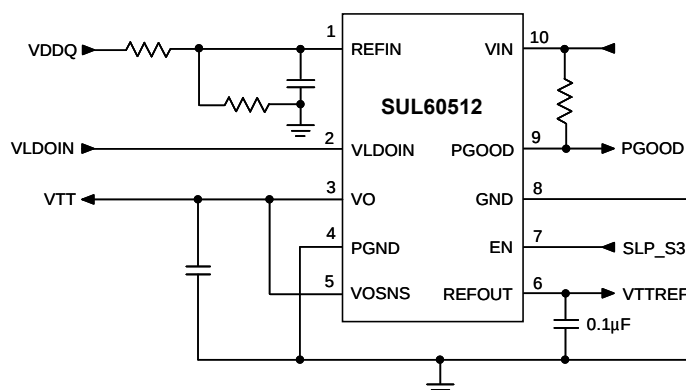
## Features

- VIN Input Voltage Range: 2.5V to 5.5V
- VLDOIN Voltage Range: 1.0V to 3.5V
- Support DDR I (1.25 VTT), DDR II (0.9 VTT), DDR III (0.75 VTT), DDR IIIL (0.675VTT) and DDR IV (0.6 VTT) Requirements
- Stable with Output Ceramic Capacitor
- PGOOD to Monitor Output Regulation
- EN Input for Shutdown Function (S3 Mode)
- Remote Sensing (VOSNS)
- $\pm 25$ mV Accuracy for VTT Refers to VTTREF
- $\pm 10$ mA Buffered Reference (VTTREF)
- Built-In Soft-Start and UVLO
- Over Current Protection
- Thermal Shutdown Protection
- TDFN3X3-10L (Thermal Pad) Package
- Lead free and halogen free

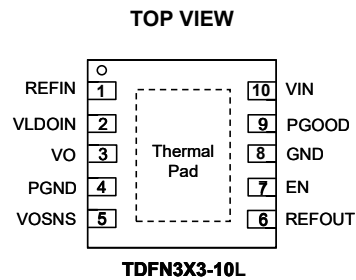
## Applications

- Memory Termination Regulator for DDR I/II/III/IIIL, Low-Power DDR III/IV
- Notebooks, Desktops and Servers
- Telecom/Datacom, Base Stations, LCD-TVs/PDP-TVs, Copiers/Printers, Set-Top Boxes

## Typical Application Circuit



## Pin Configuration



Note: Recommend connecting the Thermal Pad to the Ground for excellent power dissipation.

## Pin Description

| PIN         | NAME   | DESCRIPTIONS                                                                                                                   |
|-------------|--------|--------------------------------------------------------------------------------------------------------------------------------|
| 1           | REFIN  | Terminator reference input voltage, 1.25V for DDR I, 0.9V for DDR II, 0.75V for DDR III, 0.675V for DDR IIIL, 0.6V for DDR IV. |
| 2           | VLDOIN | Terminator power pin.                                                                                                          |
| 3           | VO     | Terminator output pin.                                                                                                         |
| 4           | PGND   | Terminator power ground.                                                                                                       |
| 5           | VOSNS  | Voltage sense input pin, connect to remote termination.                                                                        |
| 6           | REFOUT | Terminator reference output pin.                                                                                               |
| 7           | EN     | ON/OFF function for SLP_S3 mode.                                                                                               |
| 8           | GND    | Ground.                                                                                                                        |
| 9           | PGOOD  | PGOOD open-drain output.                                                                                                       |
| 10          | VIN    | Internal circuit power pin, at least 2.5V.                                                                                     |
| Thermal Pad | /      | Recommend connecting the Thermal Pad to the GND for excellent power dissipation.                                               |

## Ordering Information

| PART NO  | PACKAGE     | TEMPERATURE | QTY/REEL |
|----------|-------------|-------------|----------|
| SUL60512 | TDFN3X3-10L | -40°C~+85°C | 3000 PCS |

SUL60512 devices are Pb-free and RoHS compliant.

## Absolute Maximum Ratings

| PARAMETER                                 | SYMBOL                    | VALUE           | UNIT |
|-------------------------------------------|---------------------------|-----------------|------|
| Supply Voltage Range                      | VIN,VLDOIN,VOSNS,REFIN,EN | -0.3~+6.5       | V    |
|                                           | PGND,GND                  | -0.3~0.3        | V    |
|                                           | VO                        | -0.3~VLDOIN+0.3 | V    |
|                                           | REFOUT,PGOOD              | -0.3~+6.5       | V    |
| Thermal Resistance of Junction to Ambient | $\theta_{JA}$             | 69              | °C/W |
| Continuous Power Dissipation (TA = +25°C) | PD                        | 1.8             | W    |
| Thermal Resistance Junction to Case       | $\theta_{JC}$             | 16.5            | °C/W |
| Maximum Junction Temperature              | TJ                        | 150             | °C   |
| Storage Temperature Range                 | TSTG                      | -55~150         | °C   |
| Reflow Temperature (soldering)            |                           | 260             | °C   |

## Recommend Operating Conditions<sup>Note1</sup>

| PARAMETER                               | VALUE                 | UNIT |
|-----------------------------------------|-----------------------|------|
| VIN                                     | 2.5~5.5               | V    |
| VLDOIN                                  | 1V~ min(3.5,VIN-1)    | V    |
| VOSNS,VO                                | -0.1V~ min(3.5,VIN-1) | V    |
| EN                                      | -0.1~3.5              | V    |
| REFIN                                   | 0.5~1.8               | V    |
| PGOOD                                   | -0.1~5.5              | V    |
| REFOUT                                  | -0.1~1.8              | V    |
| PGND,GND                                | -0.1~0.1              | V    |
| TA, Operating Ambient Temperature Range | -40~+85               | °C   |

**Note1:** All voltage values are with respect to the network ground terminal unless otherwise noted.

## Electrical Characteristics

$T_A = -40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ ,  $V_{\text{VIN}} = 5\text{V}$ ,  $V_{\text{VLDOIN}} = 1.5\text{V}$ ,  $V_{\text{REFIN}} = 0.75\text{V}$ , and  $V_{\text{EN}} = V_{\text{VIN}}$ , Unless otherwise specified.

| PARAMETER                                      | SYMBOL                     | CONDITIONS                                                                                             | MIN  | TYP   | MAX   | UNIT               |
|------------------------------------------------|----------------------------|--------------------------------------------------------------------------------------------------------|------|-------|-------|--------------------|
| VIN supply current                             | $I_{\text{VIN}}$           | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 5\text{V}$                                    | ---  | 0.7   | 1     | mA                 |
| VIN standby current                            | $I_{\text{VINSTB}}$        | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} > 0.4\text{V}$ | ---  | 200   | 400   | $\mu\text{A}$      |
| VIN shutdown current                           | $I_{\text{VINSN}}$         | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} = 0\text{V}$   | ---  | 65    | 150   | $\mu\text{A}$      |
| VLDOIN supply current                          | $I_{\text{VLDOIN}}$        | $V_{\text{VIN}} = 5\text{V}$ , no load                                                                 | ---  | 1     | 100   | $\mu\text{A}$      |
| VLDOIN standby current                         | $I_{\text{VLDOINSTB}}$     | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} > 0.4\text{V}$ | ---  | 0.1   | 50    | $\mu\text{A}$      |
| VLDOIN shutdown current                        | $I_{\text{VLDOINSN}}$      | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} = 0\text{V}$   | ---  | 0.1   | 50    | $\mu\text{A}$      |
| REFIN input current                            | $I_{\text{REFIN}}$         | $V_{\text{EN}} = 5\text{V}$                                                                            | ---  | ---   | 1     | $\mu\text{A}$      |
| VOSNS input current                            | $I_{\text{VOSNS}}$         | $V_{\text{VIN}} = 5\text{V}$ , no load, $V_{\text{EN}} = 5\text{V}$                                    | ---  | ---   | 1     | $\mu\text{A}$      |
| VTT output voltage                             | $V_{\text{VTT}}$           | DDR I                                                                                                  | ---  | 1.25  | ---   | V                  |
|                                                |                            | DDR II                                                                                                 | ---  | 0.9   | ---   |                    |
|                                                |                            | DDR III                                                                                                | ---  | 0.75  | ---   |                    |
|                                                |                            | DDR IIIL                                                                                               | ---  | 0.675 | ---   |                    |
|                                                |                            | DDR IV                                                                                                 | ---  | 0.6   | ---   |                    |
| VTT output voltage tolerance refer to REOUT    | $V_{\text{VTTOS}}$         | $I_{\text{VTT}} = 0$                                                                                   | -20  | ---   | 20    | mV                 |
| VTT output voltage tolerance refer to REFOUT   | $\Delta V_{\text{VTT}}$    | $ I_{\text{VTT}}  < 2\text{A}$                                                                         | -30  | ---   | 30    | mV                 |
| VTT source current limit                       | $I_{\text{VOCLSRC}}$       | $V_{\text{T}} = \text{REFIN} * 0.90$ , $\text{PGOOD} = \text{Hi}$                                      | 3    | 4     | ---   | A                  |
| VTT sink current limit                         | $I_{\text{VOCLSNK}}$       | $V_{\text{T}} = \text{REFIN} * 1.1$ , $\text{PGOOD} = \text{Hi}$                                       | 3    | 4     | ---   | A                  |
| VO discharge current                           | $I_{\text{DISCHARGE}}$     | $V_{\text{REFIN}} = 0\text{V}$ , $V_{\text{VTT}} = 0.3\text{V}$ , $V_{\text{EN}} = 0\text{V}$          | ---  | 18    | 25    | $\Omega$           |
| PGOOD threshold                                | $V_{\text{PGTH}}$          | PGOOD lower threshold refer to REFOUT                                                                  | ---  | -20   | ---   | %                  |
|                                                |                            | PGOOD upper threshold refer to REFOUT                                                                  | ---  | 20    | ---   |                    |
|                                                |                            | PGOOD hysteresis                                                                                       | ---  | 5     | ---   |                    |
| PGOOD startup delay                            | $T_{\text{PGSTUPDLY}}$     | VOSNS is within 15% of REFOUT                                                                          | ---  | 2     | ---   | ms                 |
| PGOOD bad delay                                | $T_{\text{PGBADDLY}}$      | VOSNS is outside 20% of REFOUT                                                                         | ---  | 10    | ---   | $\mu\text{s}$      |
| PGOOD output low voltage                       | $V_{\text{PGOODLOW}}$      | $I_{\text{SINK}} = 4\text{mA}$                                                                         | ---  | ---   | 0.6 5 | V                  |
| PGOOD leakage current                          | $I_{\text{PGOODLK}}$       | VOSNS is inside of PGOOD window                                                                        | ---  | ---   | 1     | $\mu\text{A}$      |
| REFIN UVLO threshold                           | $V_{\text{REFINUVO}}$      | REFIN rising                                                                                           | 0.36 | 0.39  | 0.42  | V                  |
|                                                |                            | Hysteresis                                                                                             | ---  | 20    | ---   | mV                 |
| REFOUT output voltage                          | $V_{\text{REFOUT}}$        | DDR I                                                                                                  | ---  | 1.25  | ---   | V                  |
|                                                |                            | DDR II                                                                                                 | ---  | 0.9   | ---   |                    |
|                                                |                            | DDR III                                                                                                | ---  | 0.75  | ---   |                    |
|                                                |                            | DDR IIIL                                                                                               | ---  | 0.675 | ---   |                    |
|                                                |                            | DDR IV                                                                                                 | ---  | 0.6   | ---   |                    |
| REFOUT output voltage tolerance refer to REFIN | $\Delta V_{\text{REFOUT}}$ | $-10\text{mA} < I_{\text{REFOUT}} < 10\text{mA}$                                                       | -25  | ---   | 25    | mV                 |
| REFOUT source current limit                    | $I_{\text{REFOUTSRCL}}$    | $V_{\text{REFOUT}} = 0\text{V}$                                                                        | 10   | 40    | ---   | mA                 |
| REFOUT sink current limit                      | $I_{\text{REFOUTSNCL}}$    | $V_{\text{REFOUT}} = V_{\text{IN}}$                                                                    | 10   | 40    | ---   | mA                 |
| VIN UVLO threshold                             | $V_{\text{VINUVLO}}$       | VIN rising                                                                                             | 2.1  | 2.3   | 2.4   | V                  |
|                                                |                            | Hysteresis                                                                                             | ---  | 50    | ---   | mV                 |
| EN input voltage threshold                     | $V_{\text{ENTH}}$          | Enable rising                                                                                          | 1.7  | ---   | ---   | V                  |
|                                                |                            | Enable falling                                                                                         | ---  | ---   | 0.3   |                    |
|                                                |                            | Hysteresis                                                                                             | ---  | 0.5   | ---   |                    |
| Logic input leakage current                    | $I_{\text{ENLEAK}}$        |                                                                                                        | -1   | ---   | 1     | $\mu\text{A}$      |
| Thermal Shutdown                               | $T_{\text{SD}}$            |                                                                                                        | ---  | 150   | ---   | $^{\circ}\text{C}$ |
| Thermal Shutdown Hysteresis                    | $T_{\text{SDHYS}}$         |                                                                                                        | ---  | 25    | ---   | $^{\circ}\text{C}$ |

## Electrical Characteristics (Continued)

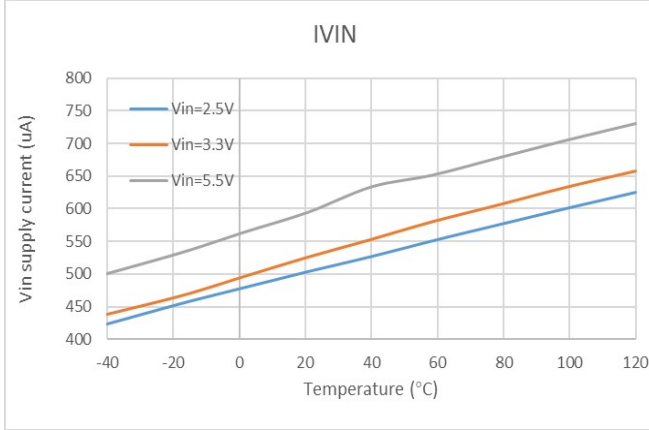
$T_A = -40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ ,  $V_{\text{VIN}} = 3.3\text{V}$ ,  $V_{\text{VLDoin}} = 1.5\text{V}$ ,  $V_{\text{REFIN}} = 0.75\text{V}$ , and  $V_{\text{EN}} = V_{\text{VIN}}$ , Unless otherwise specified.

| PARAMETER                                      | SYMBOL                     | CONDITIONS                                                                                               | MIN  | TYP   | MAX  | UNIT               |
|------------------------------------------------|----------------------------|----------------------------------------------------------------------------------------------------------|------|-------|------|--------------------|
| VIN supply current                             | $I_{\text{VIN}}$           | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 3.3\text{V}$                                  | ---  | 0.7   | 1    | mA                 |
| VIN standby current                            | $I_{\text{VINSTB}}$        | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} > 0.4\text{V}$ | ---  | 200   | 400  | $\mu\text{A}$      |
| VIN shutdown current                           | $I_{\text{VINSN}}$         | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} = 0\text{V}$   | ---  | 65    | 150  | $\mu\text{A}$      |
| VLDoin supply current                          | $I_{\text{VLDoin}}$        | $V_{\text{VIN}} = 3.3\text{V}$ , no load                                                                 | ---  | 1     | 50   | $\mu\text{A}$      |
| VLDoin standby current                         | $I_{\text{VLDoinSTB}}$     | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} > 0.4\text{V}$ | ---  | 0.1   | 50   | $\mu\text{A}$      |
| VLDoin shutdown current                        | $I_{\text{VLDoinSN}}$      | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 0\text{V}$ , $V_{\text{REFIN}} = 0\text{V}$   | ---  | 0.1   | 50   | $\mu\text{A}$      |
| REFIN input current                            | $I_{\text{REFIN}}$         | $V_{\text{EN}} = 3.3\text{V}$                                                                            | ---  | ---   | 1    | $\mu\text{A}$      |
| VOSNS input current                            | $I_{\text{VOSNS}}$         | $V_{\text{VIN}} = 3.3\text{V}$ , no load, $V_{\text{EN}} = 3.3\text{V}$                                  | ---  | ---   | 1    | $\mu\text{A}$      |
| VTT output voltage                             | $V_{\text{VTT}}$           | DDR I                                                                                                    | ---  | 1.25  | ---  | V                  |
|                                                |                            | DDR II                                                                                                   | ---  | 0.9   | ---  |                    |
|                                                |                            | DDR III                                                                                                  | ---  | 0.75  | ---  |                    |
|                                                |                            | DDR IIIL                                                                                                 | ---  | 0.675 | ---  |                    |
|                                                |                            | DDR IV                                                                                                   | ---  | 0.6   | ---  |                    |
| VTT output voltage tolerance refer to REOUT    | $V_{\text{VTTOS}}$         | $I_{\text{VTT}} = 0$                                                                                     | -20  | ---   | 20   | mV                 |
| VTT output voltage tolerance refer to REFOUT   | $\Delta V_{\text{VTT}}$    | $ I_{\text{VTT}}  < 2\text{A}$                                                                           | -30  | ---   | 30   | mV                 |
| VTT source current limit                       | $I_{\text{VOCLSRC}}$       | $V_{\text{VTT}} = \text{REFIN} * 0.90$ , $\text{PGOOD} = \text{Hi}$                                      | 3    | 4     | ---  | A                  |
| VTT sink current limit                         | $I_{\text{VOCLSNK}}$       | $V_{\text{VTT}} = \text{REFIN} * 1.1$ , $\text{PGOOD} = \text{Hi}$                                       | 3    | 4     | ---  | A                  |
| VO discharge current                           | $I_{\text{DISCHARGE}}$     | $V_{\text{REFIN}} = 0\text{V}$ , $V_{\text{VTT}} = 0.3\text{V}$ , $V_{\text{EN}} = 0\text{V}$            | ---  | 18    | 25   | $\Omega$           |
| PGOOD threshold                                | $V_{\text{PGTH}}$          | PGOOD lower threshold refer to REFOUT                                                                    | ---  | -20   | ---  | %                  |
|                                                |                            | PGOOD upper threshold refer to REFOUT                                                                    | ---  | 20    | ---  |                    |
|                                                |                            | PGOOD hysteresis                                                                                         | ---  | 5     | ---  |                    |
| PGOOD startup delay                            | $T_{\text{PGSTUPDLY}}$     | VOSNS is within 15% of REFOUT                                                                            | ---  | 2     | ---  | ms                 |
| PGOOD bad delay                                | $T_{\text{PGBADDLY}}$      | VOSNS is outside 20% of REFOUT                                                                           | ---  | 10    | ---  | $\mu\text{s}$      |
| PGOOD output low voltage                       | $V_{\text{PGOODLOW}}$      | $I_{\text{SINK}} = 4\text{mA}$                                                                           | ---  | ---   | 0.65 | V                  |
| PGOOD leakage current                          | $I_{\text{PGOODLK}}$       | VOSNS is inside of PGOOD window                                                                          | ---  | ---   | 1    | $\mu\text{A}$      |
| REFIN UVLO threshold                           | $V_{\text{REFINUVLO}}$     | REFIN rising                                                                                             | 0.36 | 0.39  | 0.42 | V                  |
|                                                |                            | Hysteresis                                                                                               | ---  | 20    | ---  | mV                 |
| REFOUT output voltage                          | $V_{\text{REFOUT}}$        | DDR I                                                                                                    | ---  | 1.25  | ---  | V                  |
|                                                |                            | DDR II                                                                                                   | ---  | 0.9   | ---  |                    |
|                                                |                            | DDR III                                                                                                  | ---  | 0.75  | ---  |                    |
|                                                |                            | DDR IIIL                                                                                                 | ---  | 0.675 | ---  |                    |
|                                                |                            | DDR IV                                                                                                   | ---  | 0.6   | ---  |                    |
| REFOUT output voltage tolerance refer to REFIN | $\Delta V_{\text{REFOUT}}$ | $-10\text{mA} < I_{\text{REFOUT}} < 10\text{mA}$                                                         | -25  | ---   | 25   | mV                 |
| REFOUT source current limit                    | $I_{\text{REFOUTSRCL}}$    | $V_{\text{REFOUT}} = 0\text{V}$                                                                          | 10   | 40    | ---  | mA                 |
| REFOUT sink current limit                      | $I_{\text{REFOUTSNCL}}$    | $V_{\text{REFOUT}} = \text{VIN}$                                                                         | 10   | 40    | ---  | mA                 |
| VIN UVLO threshold                             | $V_{\text{VINUVLO}}$       | VIN rising                                                                                               | 2.1  | 2.3   | 2.4  | V                  |
|                                                |                            | Hysteresis                                                                                               | ---  | 50    | ---  | mV                 |
| EN input voltage threshold                     | $V_{\text{ENTH}}$          | Enable rising                                                                                            | 1.7  | ---   | ---  | V                  |
|                                                |                            | Enable falling                                                                                           | ---  | ---   | 0.3  |                    |
|                                                |                            | Hysteresis                                                                                               | ---  | 0.5   | ---  |                    |
| Logic input leakage current                    | $I_{\text{ENLEAK}}$        |                                                                                                          | -1   | ---   | 1    | $\mu\text{A}$      |
| Thermal Shutdown                               | $T_{\text{SD}}$            |                                                                                                          | ---  | 150   | ---  | $^{\circ}\text{C}$ |
| Thermal Shutdown Hysteresis                    | $T_{\text{SDHYS}}$         |                                                                                                          | ---  | 25    | ---  | $^{\circ}\text{C}$ |

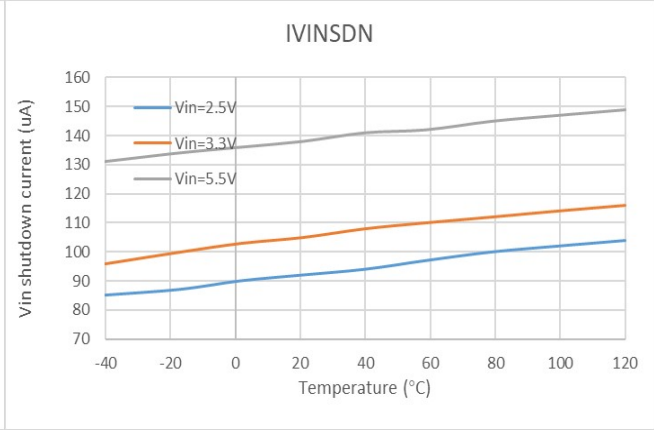
## Electrical Characteristics

$C_{VLDIN}=20\mu\text{F/MLCC/X5R}$ ,  $C_{VIN}=4.7\mu\text{F/MLCC/X7R}$ ,  $C_{REFOUT}=0.1\mu\text{F/MLCC/X7R}$ ,  $C_{OUT}=20\mu\text{F/MLCC/X5R}$ ,  $T_A=25^\circ\text{C}$ ,  
 $VDDQ=1.5\text{V}$ ,  $VLDIN=1.5\text{V}$ , unless otherwise noted.

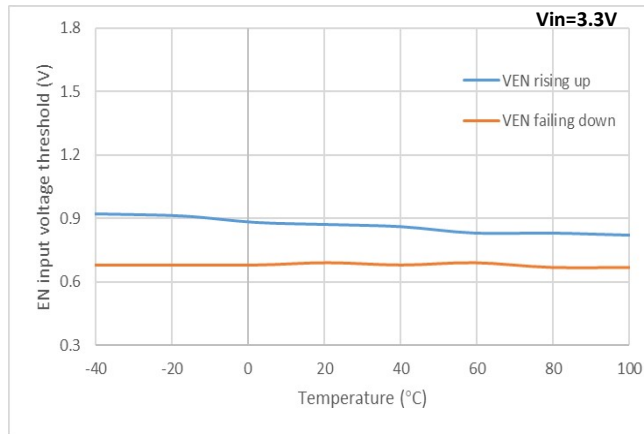
**Vin supply current vs Ambient Temperature: (Iout=0A)**



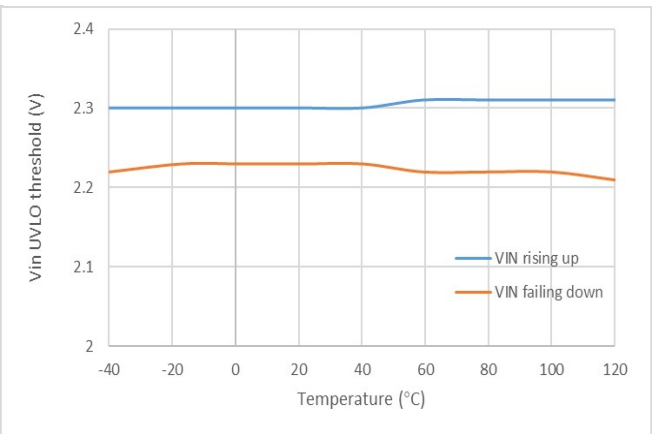
**Vin shutdown current vs Ambient Temperature: (Iout=0A)**



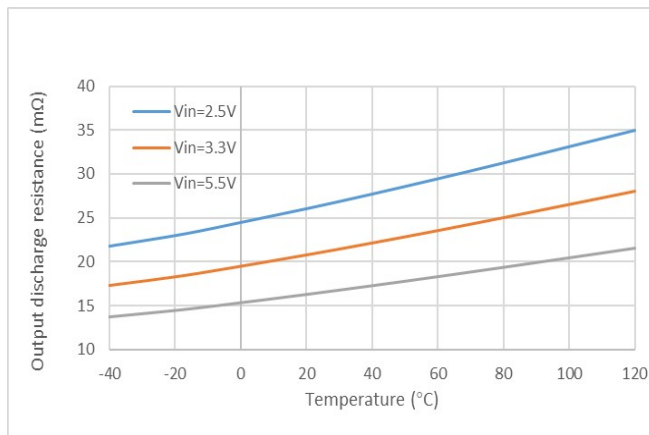
**Enable input voltage threshold vs Ambient Temperature**



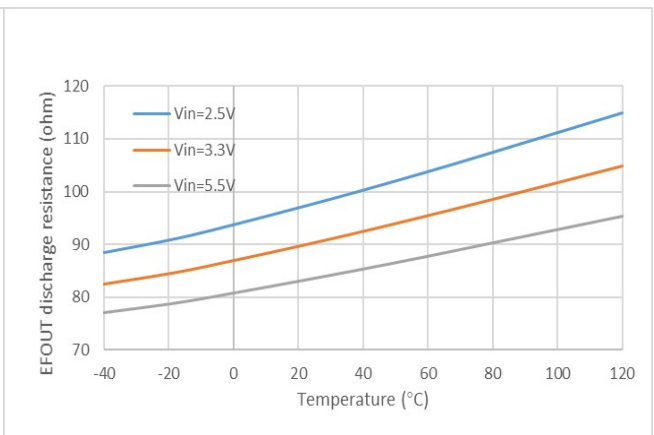
**Vin UVLO threshold**



**Output discharge resistance**



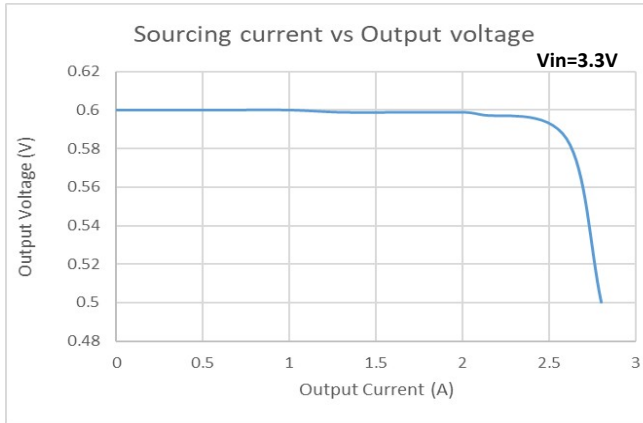
**REFOUT discharge resistance**



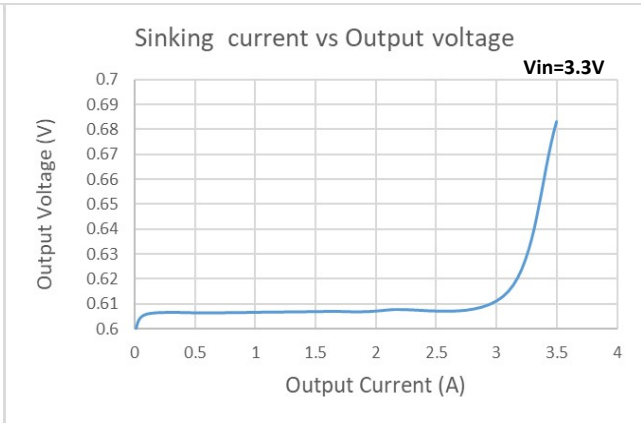
## Electrical Characteristics (Continued)

$C_{VLDIOIN}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $C_{VIN}=4.7\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{REFOUT}=0.1\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{OUT}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $T_A=25^\circ\text{C}$ ,  
 $V_{DDQ}=1.2\text{V}$ ,  $V_{LDOIN}=1.2\text{V}$ , unless otherwise noted.

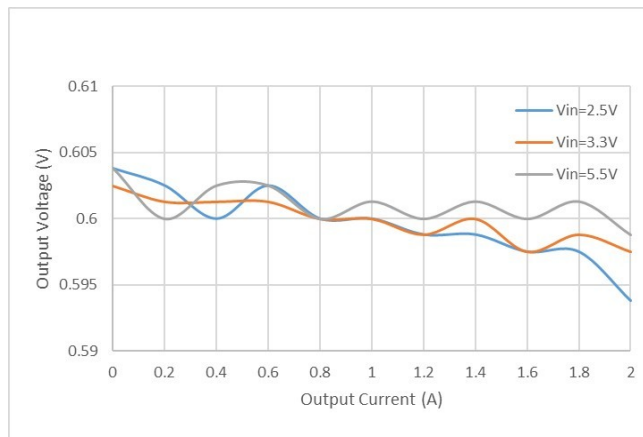
Output voltage vs Output current:Sourcing current



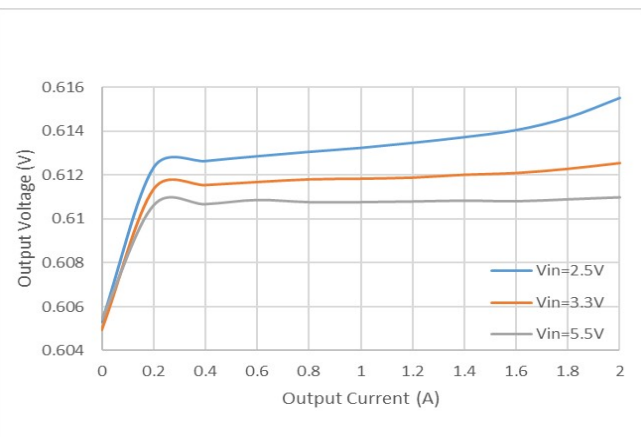
Output voltage vs Output current:Sinking current



Output voltage load regulation lout from 0A to 2A. sourcing current



Output voltage load regulation lout from 0A to 2A. sinking current



## Electrical Characteristics (Continued)

$C_{VLDIOIN}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $C_{VIN}=4.7\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{REFOUT}=0.1\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{OUT}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $T_A=25^\circ\text{C}$ ,  $V_{IN}=3.3\text{V}$ ,  $V_{DDQ}=1.2\text{V}$ ,  $V_{LDOIN}=1.2\text{V}$ , unless otherwise noted.

Vout Load transient test : Sourcing current Iout  
from 0A to 2A & 2A to 0A



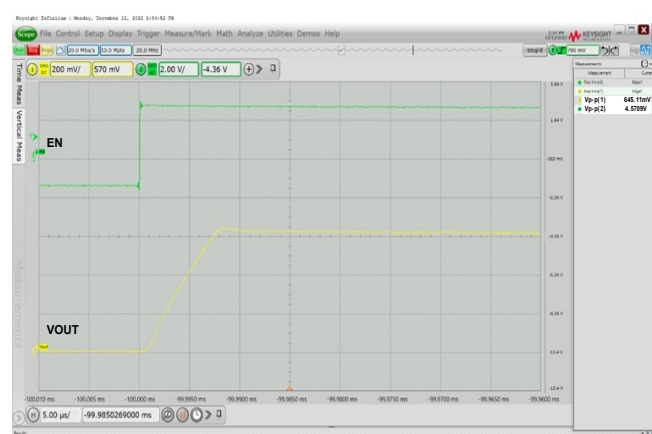
Vout Load transient test : Sinking current Iout  
from 0A to 2A



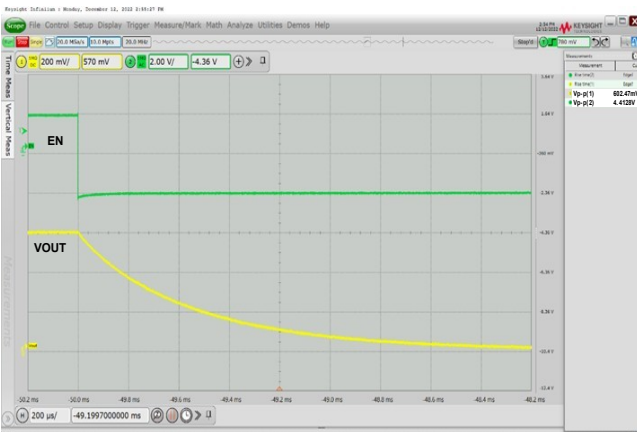
Vout Load transient test : Sinking current Iout  
from 2A to 0A



Enable power on: Iout=0A



Enable power off: Iout=0A



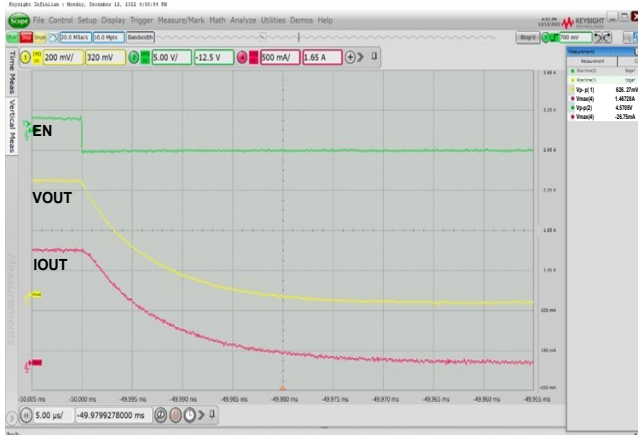
Enable power on: Iout=1.5A



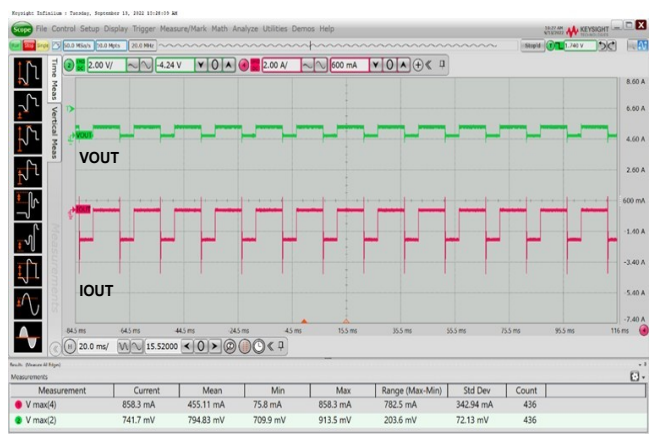
## Electrical Characteristics (Continued)

$C_{VLD0IN}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $C_{VIN}=4.7\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{REFOUT}=0.1\mu\text{F}/\text{MLCC}/\text{X7R}$ ,  $C_{OUT}=20\mu\text{F}/\text{MLCC}/\text{X5R}$ ,  $T_A=25^\circ\text{C}$ ,  $V_{IN}=3.3\text{V}$ ,  $V_{DDQ}=1.2\text{V}$ ,  $V_{LD0IN}=1.2\text{V}$ , unless otherwise noted.

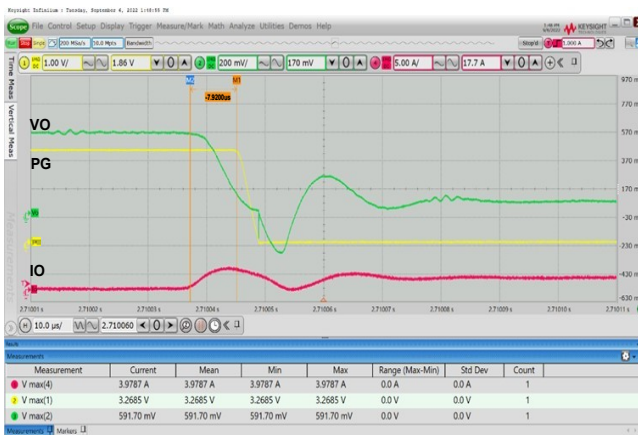
Enable power off:  $V_{IN}=3.3\text{V}$ ,  $I_{OUT}=1.5\text{A}$



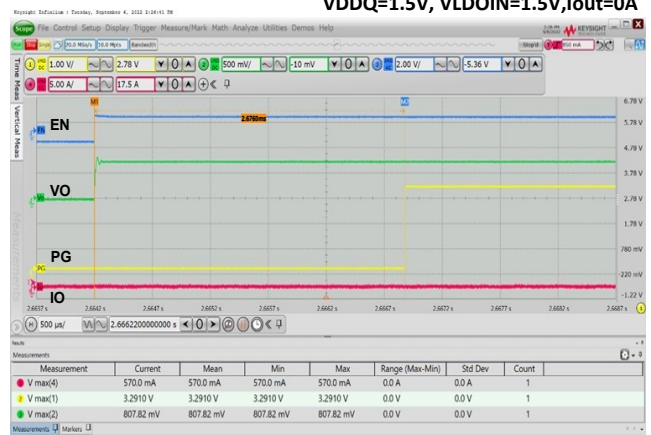
Vout shorts to ground



PGOOD bad delay



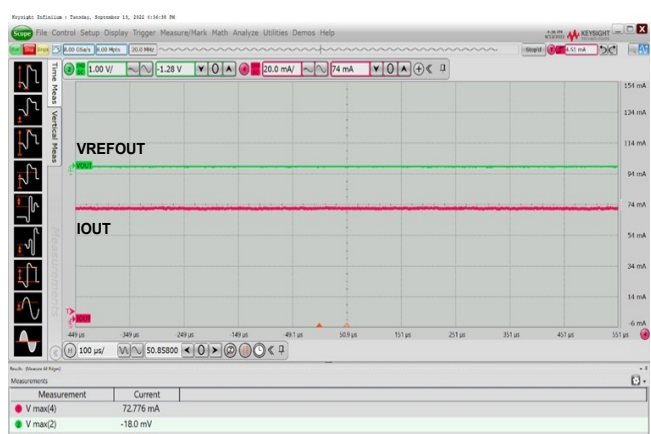
PGOOD start delay



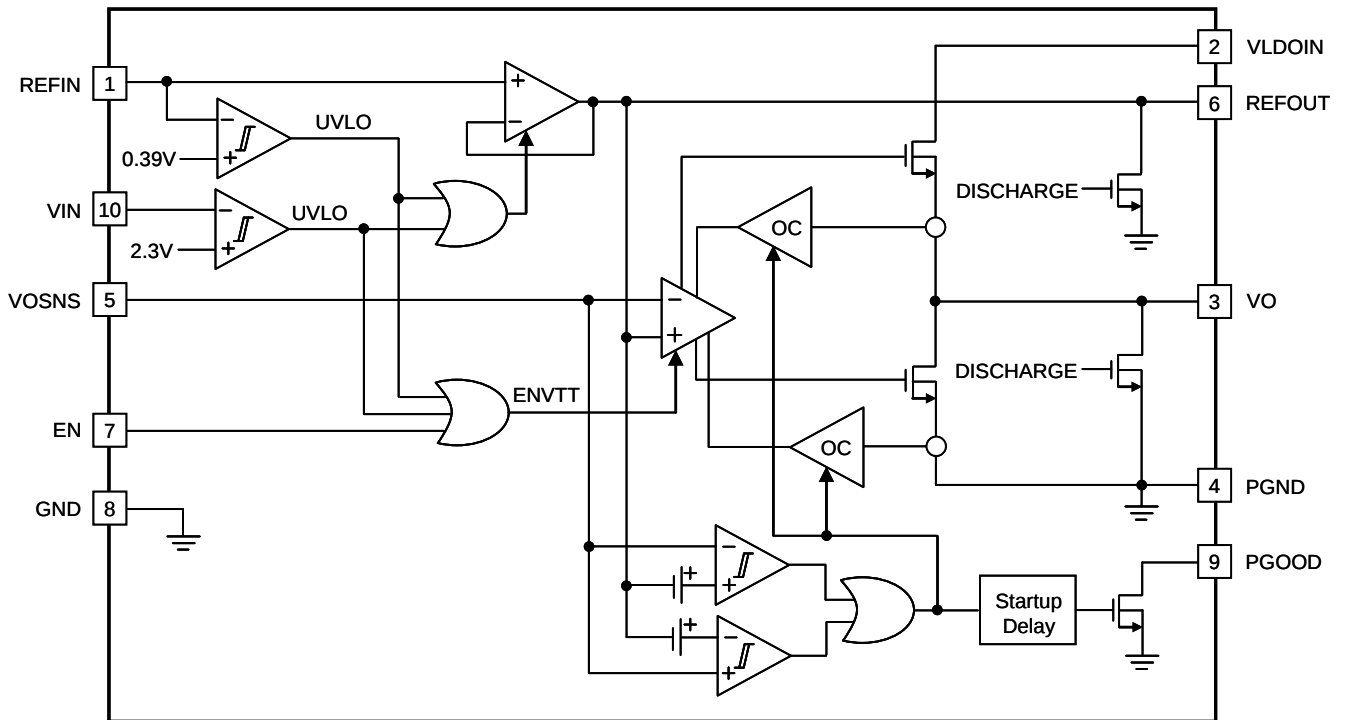
REFOUT Load transient test: Sourcing current  
IREFOUT from 0A to 10mA & 10mA to 0A



REFOUT short circuit



## Block Diagram



## Detailed Description

### VIN, VLDOIN

VIN and VLDOIN are two independent input supply pins for the SUL60512. VIN is used to supply all the internal analog circuits. VLDOIN is only used to supply the output stage to create the regulated  $V_{TT}$ . To keep the regulation successfully, VIN should be equal to or larger than VLDOIN+1V. Using a higher VLDOIN voltage will produce a larger sourcing capability from  $V_{TT}$ . But the internal power loss will also increase and then the heat increases. If the junction temperature exceeds the thermal shutdown threshold than the SUL60512 will enter the shutdown state that is the same as manual shutdown, where  $V_{TT}$  is tri-state and  $V_{REF}$  remains active.

### REFIN

When REFIN is configured for standard DDR termination applications, REFIN can be set by an external equivalent ratio voltage divider connected to the memory supply bus (VDDQ). Then, the SUL60512 generates REFOUT voltage by reference to REFIN. The REFIN voltage is supported from 0.5V to 2.5V for many types of DDR application.

### REFOUT

REFOUT generates the  $V_{TT}$  reference voltage. It has 10mA source and sink ability. REFOUT becomes active when REFIN voltage rises to 0.390 V and VIN is above the UVLO threshold. In contrast, it becomes deactivated and discharges to GND through an internal 10k $\Omega$  MOSFET when REFIN is less than 0.375V. REFOUT are independent of the EN pin state. For better performance, using an output bypass capacitor close this pin is more helpful for the noise. A ceramic capacitor in the range of 0.1 $\mu$ F to 0.01 $\mu$ F is recommended.

### VOSNS

The VOSNS pin is the feedback sensing pin of the operation amplifier which regulates the VTT voltage. In most motherboard applications, the termination resistors will connect VTT in a long plane. If using the remote sensing pin-VOSNS to the middle of the bus, the significant long-trace IR drop resulting in a termination voltage which is lower at one end than the other can be avoided. This will provide a better distribution across the entire termination bus. If the remote load regulation is not used, the VOSNS pin must still be connected to VTT for correct regulation. Care should be taken when a long VOSNS trace is implemented in close proximity to the memory. Noise pickup in the VOSNS trace can cause problems with precise regulation of VTT. A small 0.1 $\mu$ F ceramic capacitor placed next to the VOSNS pin can help to filter any high frequency signals and preventing errors.

### VO

VO is the regulated output that is used to terminate the bus resistors of DDR-SDRAM. It can precisely track the REFOUT voltage with large sinking and sourcing current capability. The maximum continuous current sourcing from VO is a function of VLDOIN. Using a higher VLDOIN will increase the source current, but it also increase the internal power dissipation and reduce the efficiency. Although the SUL60512 can deliver the larger current, care should be taken for the thermal dissipation when larger current is required. Thus, an over current function is embedded for preventing overloading and short is occurred. Also, when the temperature exceeds the junction temperature, the thermal shutdown protection is activated. That will drive the VO output into tri-state until the temperature returns below the hysteretic trigger point.

### Capacitors

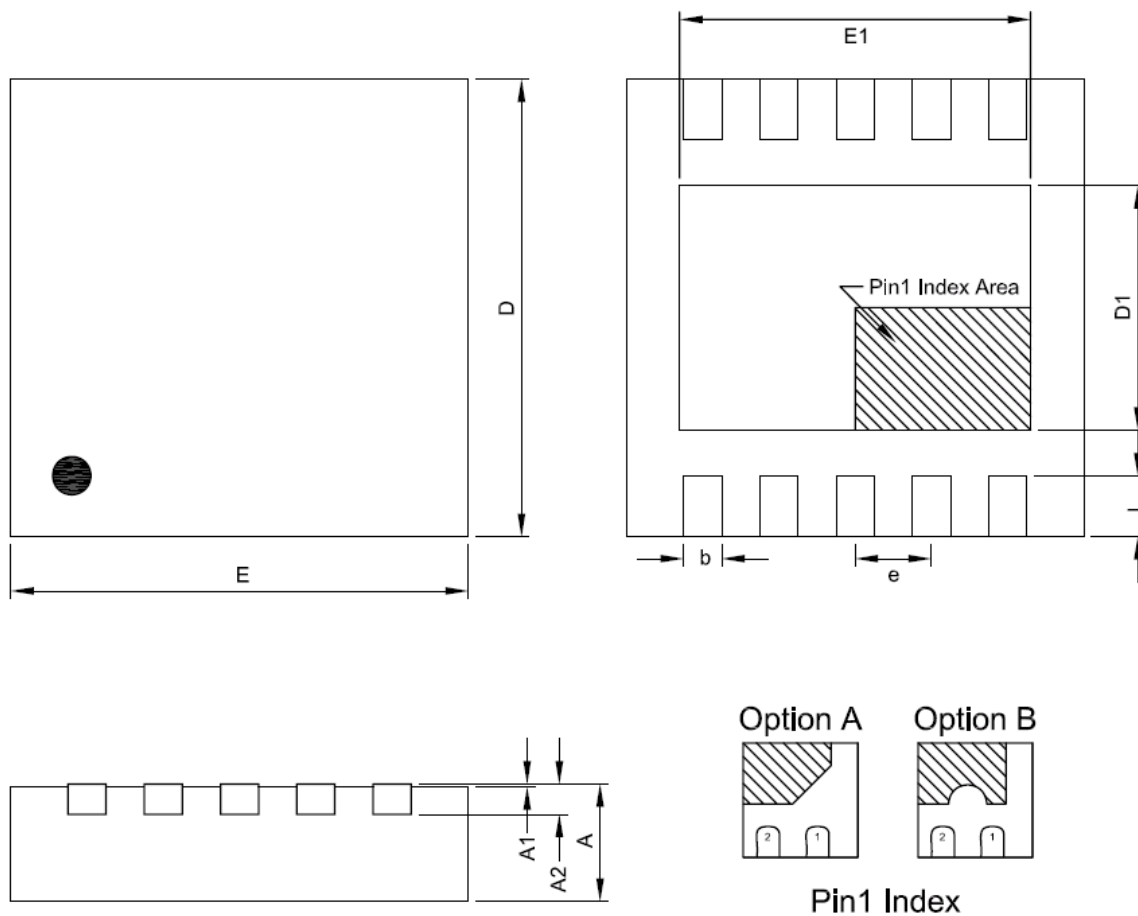
The SUL60512 does not require the capacitors for input stability, but it is recommended for improving the performance during large load transition to prevent the input power rail from dropping, especially for VLDOIN. The input capacitor for VLDOIN should be as close as possible. The typical recommended value is 50 $\mu$ F for AL electrolytic capacitors, 10 $\mu$ F with X5R for the ceramic capacitors. To prevent the excessive noise coupling into this device, an additional 0.1 $\mu$ F ceramic capacitor can be placed on the VIN power rail for the better performance.

The output capacitor of the SUL60512 is suggested to use the capacitors with low ESR. Using the capacitors with low ESR (as ceramic, OS-CON, tantalum) will have the better transition performance which is with smaller voltage drop when the peak current occurring at the transition. As a general recommendation the output capacitor should be above 20 $\mu$ F with the low ESR for SSTL applications with DDR-SDRAM.

### S3 and Pseudo-S5 Support

The SUL60512 provides S3 and pseudo-S5 support by EN and REFIN voltage level. Both REFOUT and VO are on when EN = high. While REFIN is above 0.390V but EN = low, REFOUT is maintained but VO is turned off and discharged via an internal discharge MOSFET. When REFIN voltage is less than 0.375V and EN=low, SUL60512 enters pseudo-S5 state. Both VO and REFOUT are turned off and discharged to GND through internal MOSFETs.

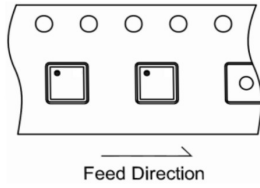
## Package Dimensions: TDFN3x3-10L



**TDFN3X3-10 Package**

| Symbol | DIMENSION IN MM |      |      | DIMENSION IN INCH |        |        |
|--------|-----------------|------|------|-------------------|--------|--------|
|        | MIN.            | NOM. | MAX. | MIN.              | NOM.   | MAX.   |
| A      | 0.70            | 0.75 | 0.80 | 0.0276            | 0.0295 | 0.0315 |
| A1     | 0.00            | ---  | 0.05 | 0.0000            | ---    | 0.0020 |
| A2     | 0.20 REF        |      |      | 0.0079 REF        |        |        |
| D      | 2.95            | 3.00 | 3.05 | 0.1161            | 0.1181 | 0.1201 |
| E      | 2.95            | 3.00 | 3.05 | 0.1161            | 0.1181 | 0.1201 |
| D1     | 1.50            | 1.60 | 1.75 | 0.0591            | 0.0630 | 0.0689 |
| E1     | 2.20            | 2.60 | 2.70 | 0.0866            | 0.1024 | 0.1063 |
| b      | 0.18            | 0.25 | 0.30 | 0.0071            | 0.0098 | 0.0118 |
| e      | 0.50 BSC        |      |      | 0.0197 BSC        |        |        |
| L      | 0.30            | 0.40 | 0.50 | 0.0118            | 0.0157 | 0.0197 |

## Taping Specification



## Minimum Footprint PCB Layout Section

